



DS055N12G

88A 120V N-Channel Enhancement Mode Power MOSFET

Features

- Uses advanced SGT technology
- High Reliability Capability
- Extremely low on-resistance RDS(on)
- Excellent gate charge x RDS(on) product(FOM)

Product Summary			
V _{DS}	R _{Ds(on)} (mΩ) Typ	I _D (A)	Q _g (Typ)
120V	5.5 @ 10V 20A	88	31nC

Mechanical Data

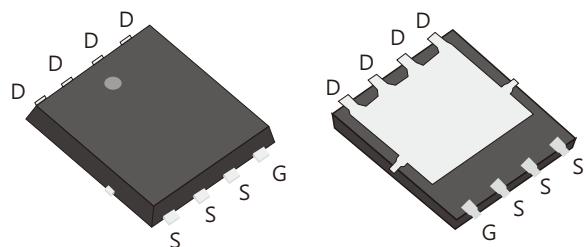
- Case:DFN5×6 Package

DFN5×6

DS055N12G

Application

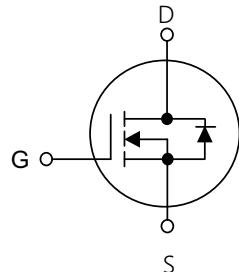
- Charger
- DC/DC converter
- Ideal for high-frequency switching and synchronous rectification



Ordering Information

Part No.	Marking.	Package Type	Package	Quality(box)
DS055N12G	DS055N12G	DFN5×6	Tape & Reel	5000

Block Diagram

Table1 Absolute Maximum Ratings (T_c=25°C, unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V _{DS}	120	V
Gate-Source Voltage		V _{GS}	±20	V
Continuous Drain Current	T _c =25°C	I _D	88	A
	T _c =100°C		56	
Pulsed Drain Current (Note 1)		I _{DM}	351	A
Single Pulse Avalanche Energy(Note 2)		E _{AS}	336	mJ
Power Dissipation T _c =25°C		P _D	96	W
Operating Junction and Storage Temperature		T _J /T _{STG}	-55~+150	°C

Table 2.Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance Junction to Ambient,Max	R _{θJA}	43	°C/W
Thermal resistance Junction to Case,Max	R _{θJC}	1.3	°C/W

Table 3. Electrical Characteristics (T_J=25°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	V _{DSS}	V _{GS} =0V,I _D =250μA	120	-	-	V
Drain-Source Leakage Current	I _{DS}	V _{DS} =120V,V _{GS} =0V	-	-	1	μA
Gate- Source Leakage Current	Forward	V _{GS} =20V,V _{DS} =0V	-	-	100	nA
	Reverse	V _{GS} =-20V,V _{DS} =0V	-	-	-100	nA
On Characteristics(Note 3)						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} ,I _D =250μA	1.2	1.7	2.5	V
Static Drain-Source On-State Resistance	R _{DSON}	V _{GS} =10V,I _D =20A	-	5.5	6.6	mΩ
		V _{GS} =4.5V,I _D =15A	-	7.2	9.0	
Dynamic Characteristics(Note 4)						
Input Capacitance	C _{iss}	V _{DS} =60V,V _{GS} =0V,f=1MHz	-	1887	-	pF
Output Capacitance	C _{oss}		-	928	-	pF
Reverse Transfer Capacitance	C _{rss}		-	13	-	pF
Switching Characteristics (Note 4)						
Turn-On Delay Time	t _{d(on)}	V _{DS} =60V, V _{GS} =10V,R _L =3Ω,	-	5.4	-	ns
Turn-On Rise Time	t _r		-	4.5	-	ns
Turn-Off Delay Time	t _{d(off)}		-	25	-	ns
Turn-Off Fall Time	t _f		-	13	-	ns
Total Gate Charge	Q _G	V _{DS} =60V,I _D =20A, V _{GS} =10V	-	31	-	nC
Gate-Source Charge	Q _{GS}		-	5.2	-	nC
Gate-Drain Charge	Q _{GD}		-	7.2	-	nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =20A	-	-	1.2	V
Maximum Continuous Drain-Source Diode Forward Current	I _S		-	-	88	A
Reverse Recovery Time	t _{rr}	V _{GS} =0V, I _F =100A dI _F /dt=100A/μs	-	57	-	ns
Reverse Recovery Charge	Q _{RR}		-	105	-	nC

Notes : 1 Repetitive Rating:Pulse width limited by maximum junction temperature

2 L=0.5mH, R_G=25Ω,Starting T_J=25°C

3 Pulse Test: Pulse width ≤300μS, Duty cycle≤2%

4 Guaranteed by design,not subject to production

Typical Characteristics Diagrams

Figure 1. Output Characteristics

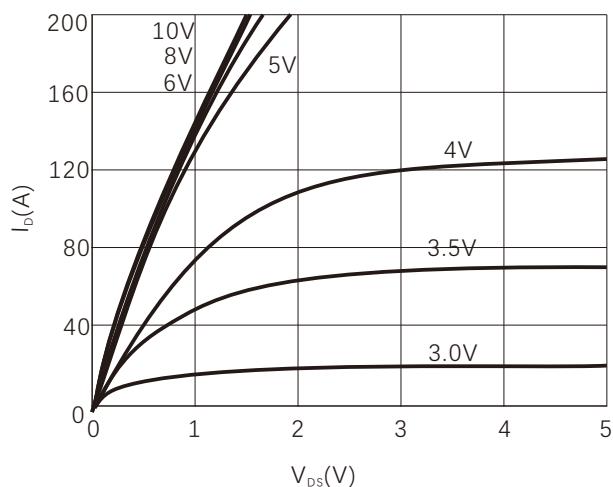


Figure 2. Normalized $R_{DS(ON)}$ vs Temperature

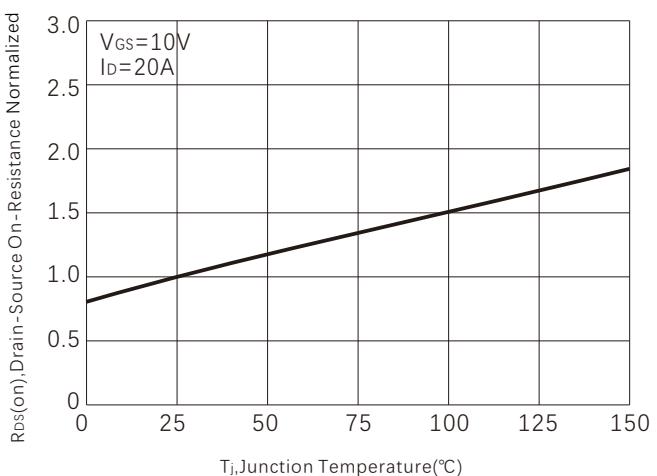


Figure 3. On-Resistance vs. Drain Current

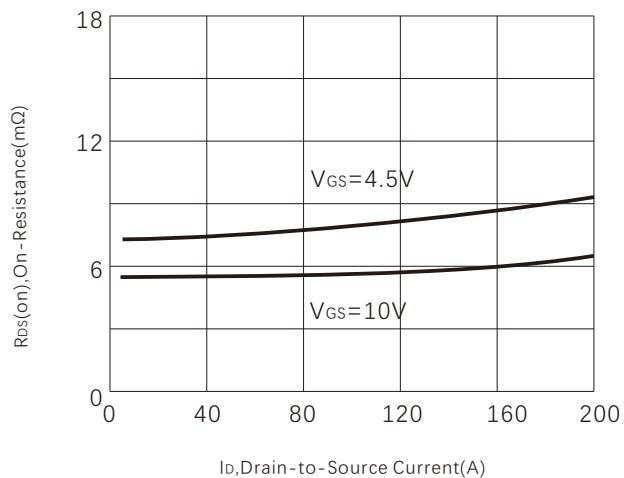


Figure 4. Capacitance

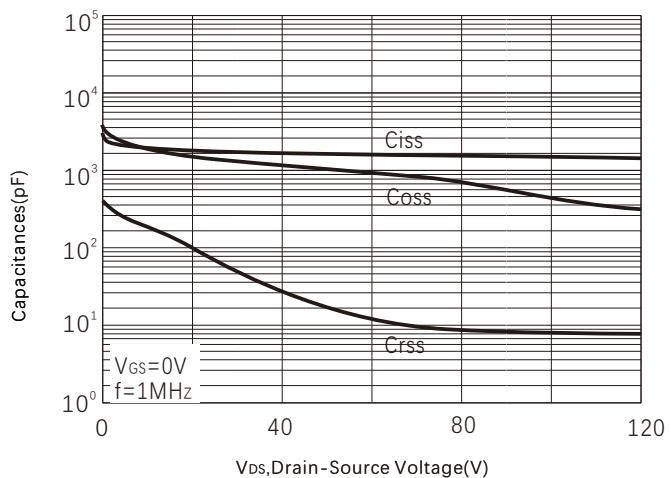


Figure 5. Gate charge

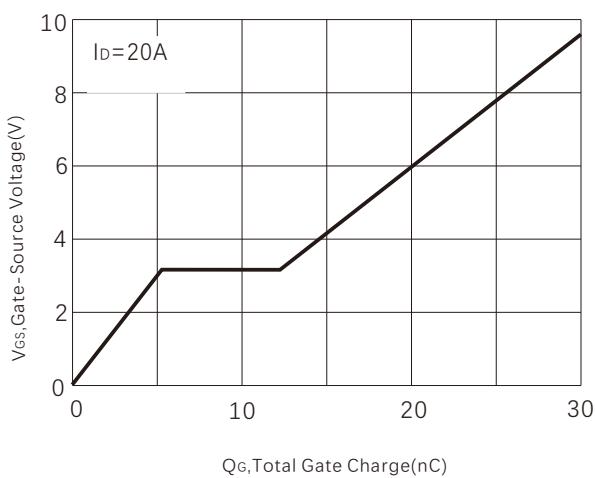


Figure 6. Source-Drain Diode Forward Voltage

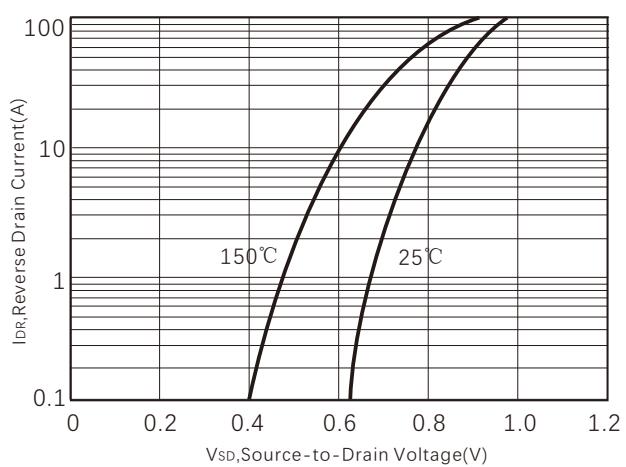


Figure 7. Maximum Drain Current vs Temperature

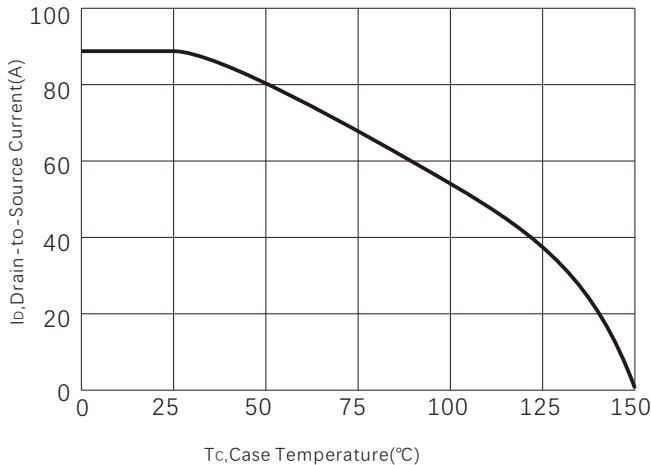


Figure 8. Transfer Characteristics

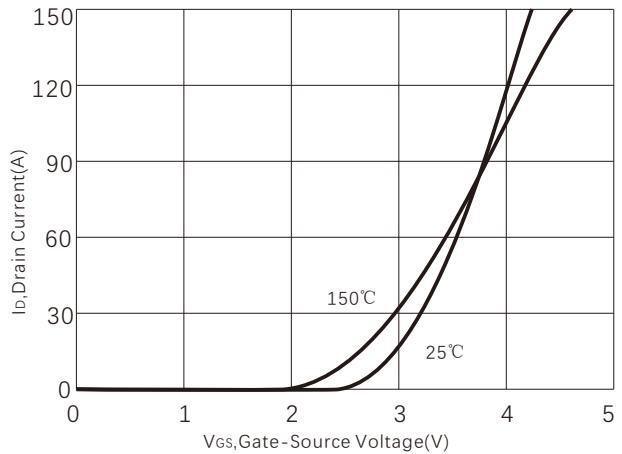


Figure 9.

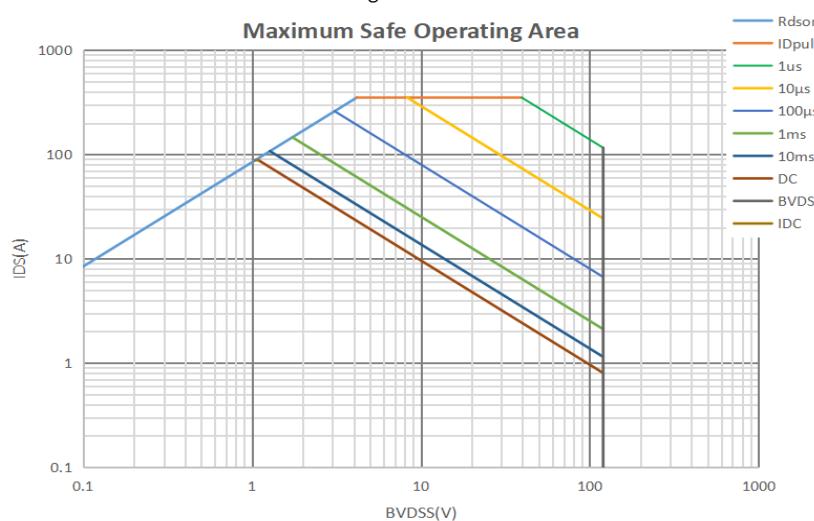
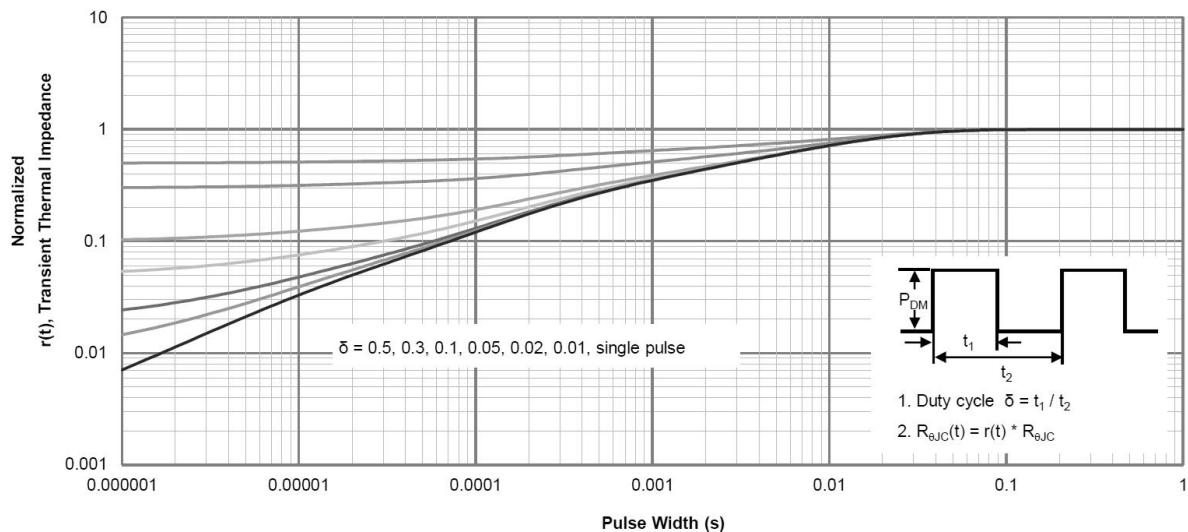
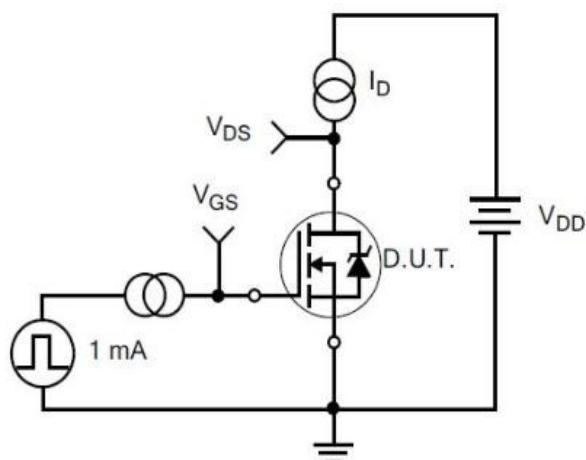


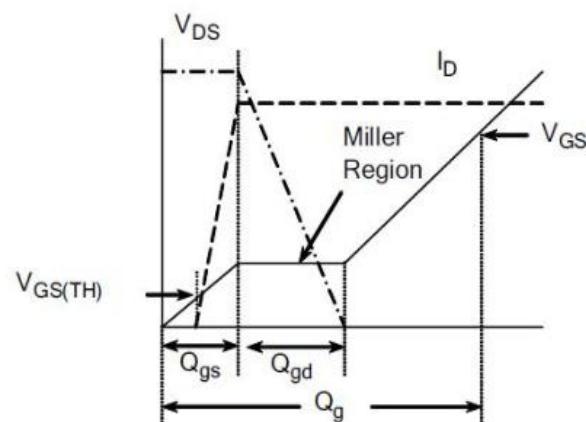
Figure 10. Normalized Maximum Transient Thermal Impedance



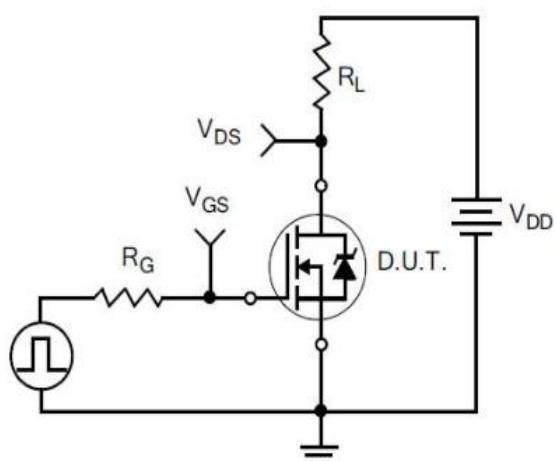
Typical Test Circuit



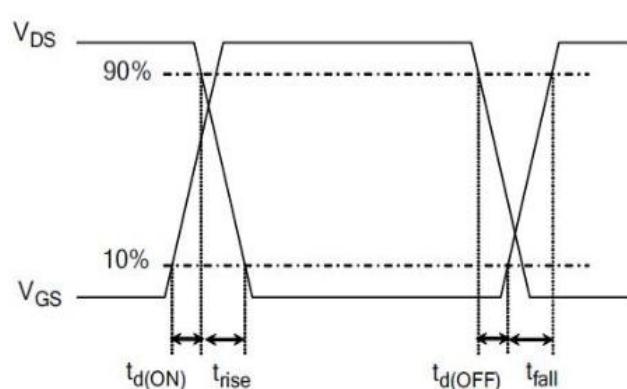
1) Gate Charge Test Circuit



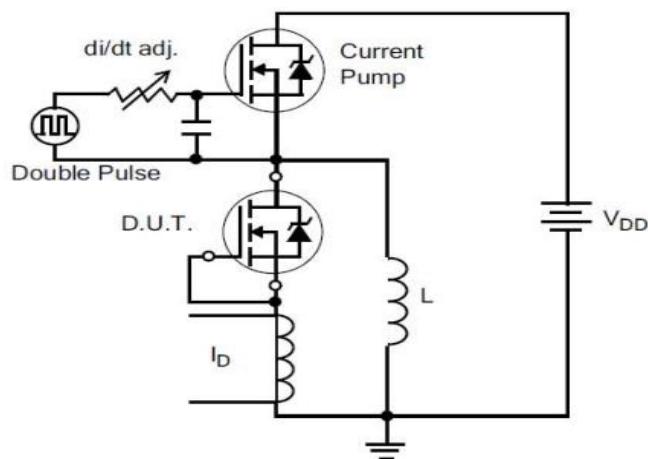
2) Gate Charge Waveform



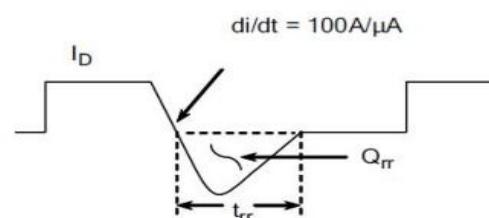
3) Resistive Switching Test Circuit



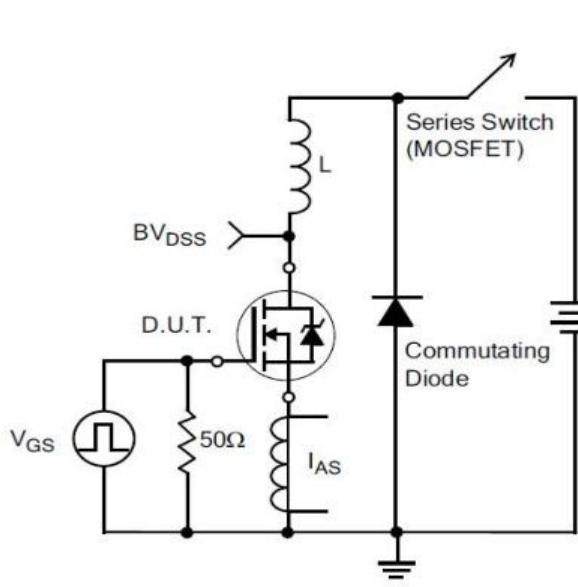
4) Resistive Switching Waveforms



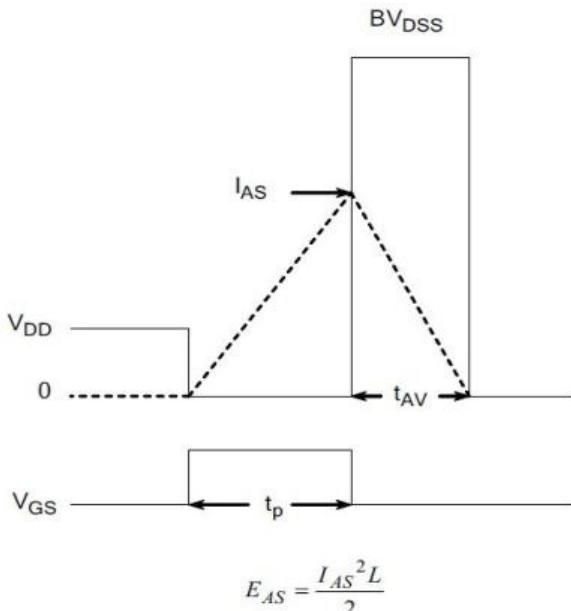
5) Diode Reverse Recovery Test Circuit



6) Diode Reverse Recovery Waveform

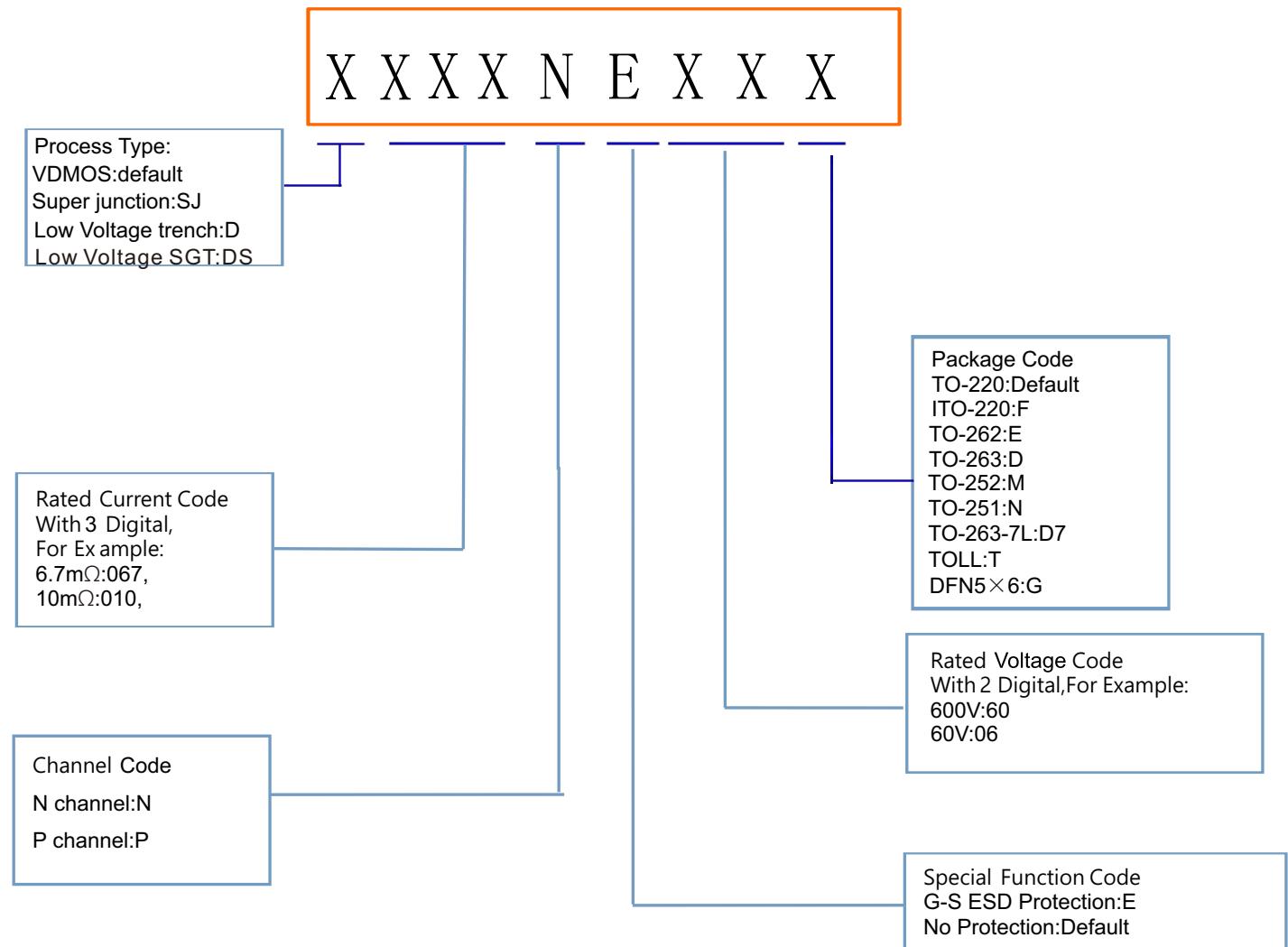


7) Unclamped Inductive Switching Test Circuit



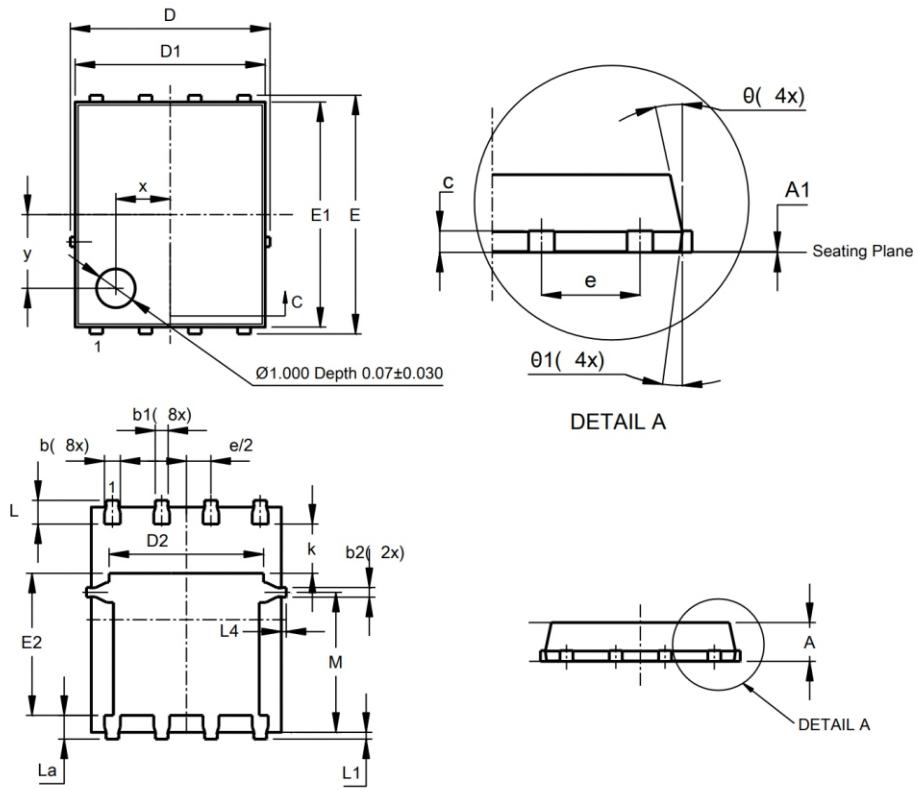
8) Unclamped Inductive Switching Waveforms

Product Names Rules



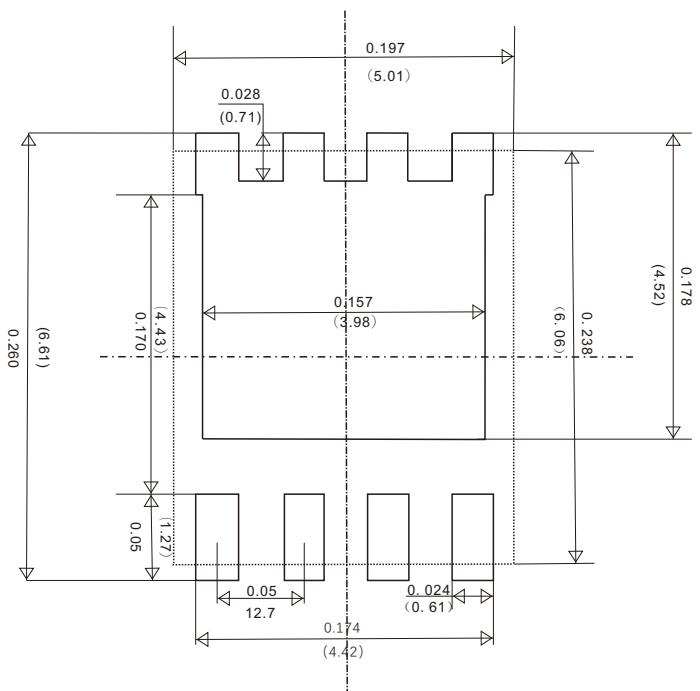
Dimensions

DFN5×6 PACKAGE OUTLINE DIMENSIONS



Suggested Pad Layout

Dim	Min	Max	Type
A	0.90	1.10	1.00
b	0.23	0.41	0.32
b1	0.24	0.30	0.27
b2	0.16	0.32	0.23
c	0.17	0.27	0.22
D	-	-	5.01
D1	4.80	4.95	4.88
D2	-	-	3.98
E	-	-	6.06
E1	5.72	5.82	5.77
E2	3.42	3.52	3.47
k	-	-	1.33
L	0.56	0.66	0.61
La	0.57	0.67	0.63
L1	0.06	0.15	0.11
L4	-	-	0.06
M	3.00	3.20	3.08
Ø	10	11	10.39



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